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January 1999 Revised June 2005

## 74LVT162245 • 74LVTH162245

# Low Voltage 16-Bit Transceiver with 3-STATE Outputs and $25\Omega$ Series Resistors in A Port Outputs

#### **General Description**

The LVT162245 and LVTH162245 contains sixteen noninverting bidirectional buffers with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. Each byte has separate control inputs which can be shorted together for full 16-bit operation. The  $T/\overline{R}$ inputs determine the direction of data flow through the device. The  $\overline{OE}$  inputs disable both the A and B ports by placing them in a high impedance state.

The LVT162245 and LVTH162245 are designed with equivalent  $25\Omega$  series resistance in both the HIGH and LOW states on the A Port outputs. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus transceivers/transmitters.

The LVTH162245 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These non-inverting transceivers are designed for low voltage (3.3V)  $V_{CC}$  applications, but with the capability to provide a TTL interface to a 5V environment. The LVT162245 and LVTH162245 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining a low power dissipation.

#### Features

- Input and output interface capability to systems at 5V V<sub>CC</sub>
- Bushold data inputs eliminate the need for external pullup resistors to hold unused inputs (74LVTH162245), also available without bushold feature (74LVT162245).
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- A Port outputs include equivalent series resistance of 25Ω making external termination resistors unnecessary and reducing overshoot and undershoot
- A Port outputs source/sink ±12 mA. B Port outputs source/sink -32 mA/+64 mA
- Functionally compatible with the 74 series 162245
- Latch-up performance exceeds 500 mA
- ESD performance: Human-body model > 2000V Machine model > 200V Charged-device model > 1000V
- Also packaged in plastic Fine Pitch Ball Grid Array (FBGA)

#### **Ordering Code:**

•		
Order Number	Package Number	Package Description
74LVT162245G (Note 1)(Note 2)	BGA54A (Preliminary)	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
74LVT162245MEA (Note 2)	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74LVT162245MTD (Note 2)	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
74LVTH162245G (Note 1)(Note 2)	BGA54A	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
74LVTH162245MEA	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide [TUBE]
74LVTH162245MEX	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide [TAPE and REEL]
74LVTH162245MTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide [TUBE]
74LVTH162245MTX	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide [TAPE and REEL]
N + + 0 +	<b>.</b>	

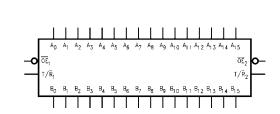
Note 1: Ordering code "G" indicates Trays.

Note 2: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

74LVT162245 • 74LVTH162245 Low Voltage 16-Bit Transceiver with 3-STATE Outputs and 25 $\Omega$  Series Resistors

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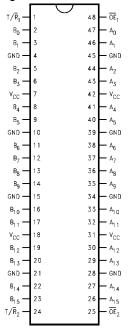
Port Outputs



#### **Connection Diagrams**

Logic Symbol

Pin Assignments for SSOP and TSSOP



#### Pin Assignment for FBGA 1 2 3 4 5 6 000000 ∢ в 000000 000000 Ο Δ ш 000000 ш G 000000 000000 т

(Top Thru View)

#### **Pin Descriptions**

Pin Names	Description
OEn	Output Enable Input (Active LOW)
T/R <sub>n</sub>	Transmit/Receive Input
A <sub>0</sub> -A <sub>15</sub>	Side A Inputs/3-STATE Outputs
A <sub>0</sub> -A <sub>15</sub> B <sub>0</sub> -B <sub>15</sub> NC	Side B Inputs/3-STATE Outputs
NC	No Connect

#### **FBGA Pin Assignments**

	1	2	3	4	5	6
Α	B <sub>0</sub>	NC	T/R <sub>1</sub>	OE <sub>1</sub>	NC	A <sub>0</sub>
В	B <sub>2</sub>	B <sub>1</sub>	NC	NC	A <sub>1</sub>	A <sub>2</sub>
С	B <sub>4</sub>	B <sub>3</sub>	V <sub>CC</sub>	V <sub>CC</sub>	A <sub>3</sub>	A <sub>4</sub>
D	B <sub>6</sub>	В <sub>5</sub>	GND	GND	A <sub>5</sub>	A <sub>6</sub>
Е	B <sub>8</sub>	B <sub>7</sub>	GND	GND	A <sub>7</sub>	A <sub>8</sub>
F	B <sub>10</sub>	B <sub>9</sub>	GND	GND	A <sub>9</sub>	A <sub>10</sub>
G	B <sub>12</sub>	В <sub>11</sub>	V <sub>CC</sub>	V <sub>CC</sub>	A <sub>11</sub>	A <sub>12</sub>
Н	B <sub>14</sub>	B <sub>13</sub>	NC	NC	A <sub>13</sub>	A <sub>14</sub>
J	B <sub>15</sub>	NC	$T/R_2$	$\overline{\text{OE}}_2$	NC	A <sub>15</sub>

### **Truth Tables**

Inp	outs	Outrasta
OE <sub>1</sub>	T/R <sub>1</sub>	- Outputs
L	L	Bus $B_0 - B_7$ Data to Bus $A_0 - A_7$
L	Н	Bus $A_0 - A_7$ Data to Bus $B_0 - B_7$
н	Х	HIGH-Z State on A <sub>0</sub> -A <sub>7</sub> , B <sub>0</sub> -B <sub>7</sub>

Inp	outs	Outrasta
OE <sub>2</sub>	T/R <sub>2</sub>	Outputs
L	L	Bus $B_8 - B_{15}$ Data to Bus $A_8 - A_{15}$
L	н	Bus $A_8 - A_{15}$ Data to Bus $B_8 - B_{15}$
н	Х	HIGH-Z State on A8-A15, B8-B15

H = HIGH Voltage Level

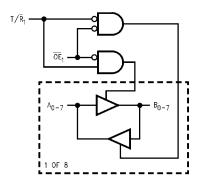
L = LOW Voltage Level X = Immaterial

Z = High Impedance

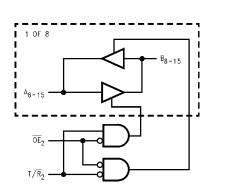
### **Functional Description**

The LVT162245 and LVTH162245 contain sixteen noninverting bidirectional buffers with 3-STATE outputs. The device is byte controlled with each byte functioning identi-

### **Logic Diagrams**



cally, but independent of the other. The control pins can be shorted together to obtain full 16-bit operation.



Please note that these diagrams are provided only for the understanding of logic operations and should not be used to estimate propagation delays.

74LVT162245 • 74LVTH162245

Symbol	Parameter	Value	Conditions	Units
V <sub>CC</sub>	Supply Voltage	-0.5 to +4.6		V
VI	DC Input Voltage	-0.5 to +7.0		V
Vo	Output Voltage	-0.5 to +7.0	Output in 3-STATE	V
		-0.5 to +7.0	Output in HIGH or LOW State (Note 4)	- ·
I <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
I <sub>ОК</sub>	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
lo	DC Output Current	64	V <sub>O</sub> > V <sub>CC</sub> Output at HIGH State	
		128	V <sub>O</sub> > V <sub>CC</sub> Output at LOW State	mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	±64		mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±128		mA
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C

## **Recommended Operating Conditions**

Symbol	Parameter		Min	Max	Units	
V <sub>CC</sub>	Supply Voltage	2.7	3.6	V		
VI	Input Voltage		0	5.5	V	
I <sub>ОН</sub>	HIGH-Level Output Current	B Port		-32	mA	
		A Port		-12	IIIA	
I <sub>OL</sub>	LOW-Level Output Current	B Port		64	mA	
		A Port		12	ША	
T <sub>A</sub>	Free Air Operating Temperature		-40	+85	°C	
Δt/ΔV	Input Edge Rate, V <sub>IN</sub> = 0.8V–2.0V, V <sub>CC</sub> = 3.0V		0	10	ns/V	

Note 3: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied. Note 4: I<sub>O</sub> Absolute Maximum Rating must be observed.

## **DC Electrical Characteristics**

Symbol	Parame	tor	V <sub>CC</sub>	T <sub>A</sub> = -40°C	to +85°C	Units	Conditions
Symbol	Parame	ter	(V)	Min	Max	Units	Conditions
V <sub>IK</sub>	Input Clamp Diode Volta	ge	2.7		-1.2	V	I <sub>I</sub> = -18 mA
/ <sub>IH</sub>	Input HIGH Voltage		2.7-3.6	2.0		V	$V_0 \le 0.1V \text{ or}$
/ <sub>IL</sub>	Input LOW Voltage		2.7-3.6		0.8	V	$V_O \ge V_{CC} - 0.1V$
V <sub>OH</sub>	Output HIGH Voltage		3.0	2.0		V	I <sub>OH</sub> = -12 mA
		A Port	2.7–3.6	V <sub>CC</sub> -0.2		V	I <sub>OH</sub> = -100 μA
		B Port	2.7	2.4		V	I <sub>OH</sub> = -8 mA
	BFOIL	3.0	2.0		v	I <sub>OH</sub> = -32 mA	
V <sub>OL</sub>	Output LOW Voltage	A Port	3.0		0.8		I <sub>OL</sub> = 12 mA
		AFOIL	2.7		0.2	V	I <sub>OL</sub> = 100 μA
			2.7		0.5	v	I <sub>OL</sub> = 24 mA
		B Port	3.0		0.4		I <sub>OL</sub> = 16 mA
		BFOIL	3.0		0.5		I <sub>OL</sub> = 32 mA
			3.0		0.55		I <sub>OL</sub> = 64 mA
I(HOLD)	Bushold Input Minimum	Drive	3.0	75		uА	$V_I = 0.8V$
(Note 5)			5.0	-75		μΛ	$V_{I} = 2.0V$
I(OD)	Bushold Input Over-Drive	e	3.0	500		uА	(Note 6)
(Note 5)	Current to Change State		5.0	-500		μΛ	(Note 7)
I <sub>I</sub>	Input Current		3.6		10		$V_I = 5.5V$
		Control Pins	3.6		±1	uА	$V_I = 0V \text{ or } V_{CC}$
		Doto Dino	3.6		-5	μА	$V_I = 0V$
	Data Pins		3.0		1		$V_I = V_{CC}$
OFF	Power Off Leakage Curr	ent	0		±100	μA	$0V \le V_1 \text{ or } V_0 \le 5.5V$

<b>DC Electrical Characteristics</b>	(Continued)
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Symbol	Parameter	V <sub>cc</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Gymbol	i arameter	(V)	Min	Max	Units	Conditions	
I <sub>PU/PD</sub>	Power Up/Down 3-STATE Current	0–1.5V		±100	μA	$V_{O} = 0.5V$ to 3.0V $V_{I} = GND$ to $V_{CC}$	
I <sub>OZL</sub>	3-STATE Output Leakage Current	3.6		-5	μΑ	$V_0 = 0.5V$	
I <sub>OZL</sub> (Note 5)	3-STATE Output Leakage Current	3.6		-5	μΑ	V <sub>O</sub> = 0.0V	
I <sub>OZH</sub>	3-STATE Output Leakage Current	3.6		5	μA	$V_0 = 3.0V$	
I <sub>OZH</sub> (Note 5)	3-STATE Output Leakage Current	3.6		5	μΑ	V <sub>O</sub> = 3.6V	
I <sub>OZH</sub> +	3-STATE Output Leakage Current	3.6		10	μA	$V_{CC} < V_O \le 5.5 V$	
I <sub>CCH</sub>	Power Supply Current	3.6		0.19	mA	Outputs HIGH	
I <sub>CCL</sub>	Power Supply Current	3.6		5	mA	Outputs LOW	
I <sub>CCZ</sub>	Power Supply Current	3.6		0.19	mA	Outputs Disabled	
I <sub>CCZ+</sub>	Power Supply Current	3.6		0.19	mA	$V_{CC} \le V_O \le 5.5V$ , Outputs Disabled	
ΔI <sub>CC</sub>	Increase in Power Supply Current (Note 8)	3.6		0.2	mA	One Input at $V_{CC} - 0.6V$ Other Inputs at $V_{CC}$ or GND	

Note 5: Applies to Bushold versions only (74LVTH162245).

Note 6: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 7: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 8: This is the increase in supply current for each input that is at the specified voltage level rather than  $V_{CC}$  or GND.

## Dynamic Switching Characteristics (Note 9)

Symbol	Parameter	$V_{CC}$ $T_A = 25^{\circ}C$		Units	Conditions			
Cymbol	i alameter	(V)	Min	Тур Мах		Onita	$\textbf{C}_{\textbf{L}}=\textbf{50}~\textbf{pF},~\textbf{R}_{\textbf{L}}=\textbf{500}\Omega$	
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	3.3		0.8		V	(Note 10)	
VOLV	Quiet Output Minimum Dynamic VO	3.3		-0.8		V	(Note 10)	

Note 9: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 10: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

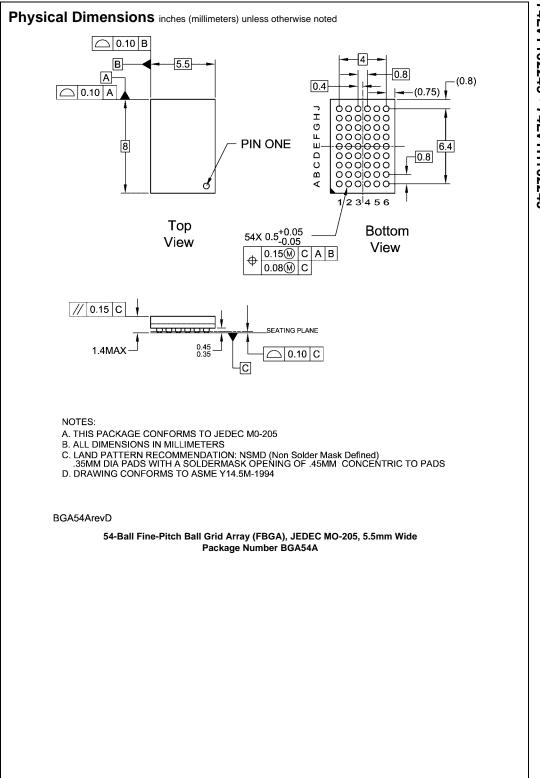
		T <sub>A</sub> = -40°C to +85°C C <sub>1</sub> = 50 pF, R <sub>1</sub> = 500Ω					
Symbol	Parameter	V <sub>CC</sub> = 3.	= 2.7V	Units			
		V <sub>CC</sub> = 3.	3V ± 0.3V Max	V <sub>CC</sub> =	4		
t <sub>PLH</sub>	Propagation Delay Data to A Port Output	1.0	4.0	1.0	Max 4.6	-	
t <sub>PHL</sub>	riopagaion Dolay Dala to rri on Dapat	1.0	3.7	1.0	4.1	ns	
t <sub>PLH</sub>	Propagation Delay Data to B Port Output	1.0	3.5	1.0	3.9		
t <sub>PHL</sub>		1.0	3.5	1.0	3.9	ns	
t <sub>PZH</sub>	Output Enable Time for A Port Output	1.0	5.3	1.0	6.3		
t <sub>PZL</sub>		1.0	5.6	1.0	7.2	ns	
t <sub>PZH</sub>	Output Enable Time for B Port Output	1.0	4.6	1.0	5.4	ns	
t <sub>PZL</sub>		1.0	5.3	1.0	6.9	115	
t <sub>PHZ</sub>	Output Disable Time for A Port Output	1.5	5.6	1.5	6.3	ns	
t <sub>PLZ</sub>		1.5	5.5	1.5	5.5	115	
t <sub>PHZ</sub>	Output Disable Time for B Port Output	1.5	5.4	1.5	6.1	ns	
t <sub>PLZ</sub>		1.5	5.1	1.5	5.4	115	
t <sub>OSHL</sub>	A Port Output to Output Skew		1.0		1.0	ns	
t <sub>OSLH</sub>	(Note 11)		1.0		1.0	115	
t <sub>OSHL</sub>	B Port Output to Output Skew		1.0		1.0	ns	
t <sub>OSLH</sub>	(Note 11)		1.0		1.0	115	

Note 11: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

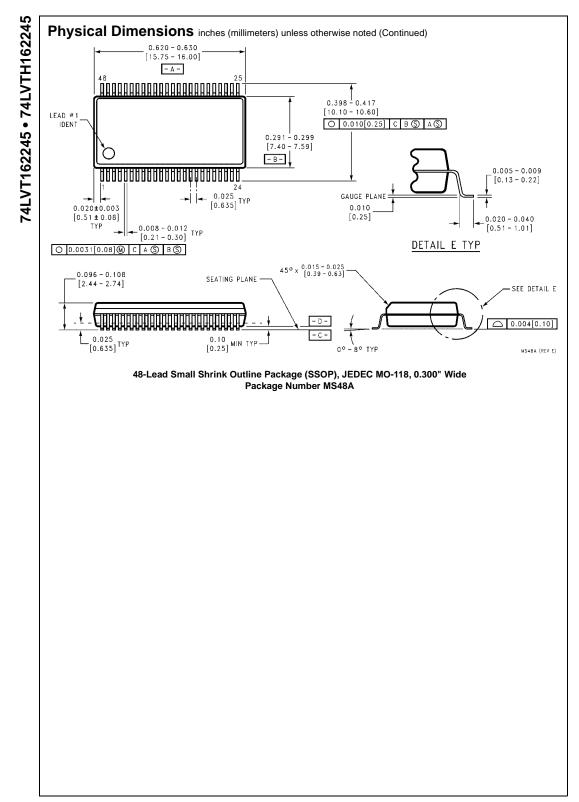
## Capacitance (Note 12)

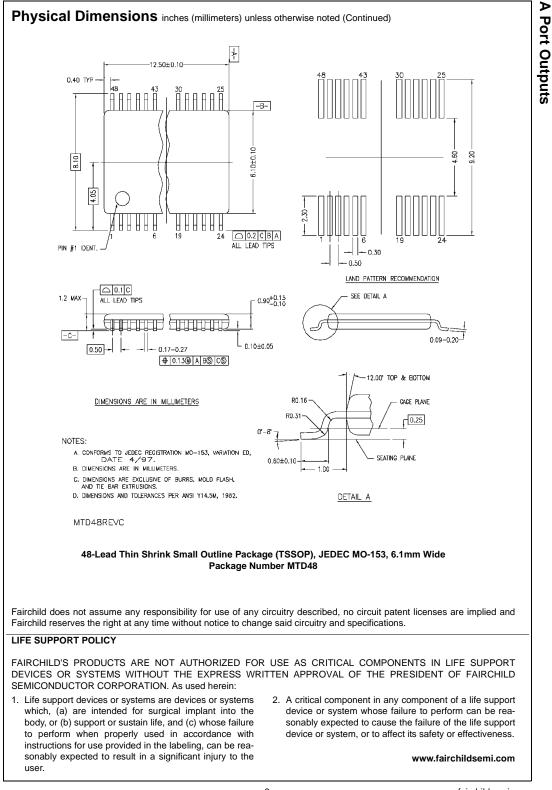
Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = 0V$ , $V_I = 0V$ or $V_{CC}$	4	pF
C <sub>I/O</sub>	Input/Output Capacitance	$V_{CC} = 3.0V$ , $V_O = 0V$ or $V_{CC}$	8	pF

Note 12: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.



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